

MC74LCXU04

Low-Voltage CMOS Unbuffered Hex Inverter

With 5 V-Tolerant Inputs

The MC74LCXU04 is a high performance unbuffered hex inverter operating from a 2.3 to 3.6 V supply. (High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance.) A V_I specification of 5.5 V allows MC74LCXU04 inputs to be safely driven from 5 V devices.

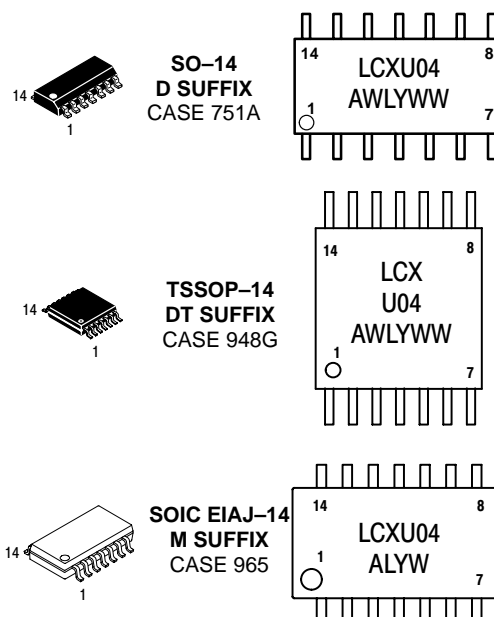
- Designed for 2.3 to 3.6 V V_{CC} Operation
- 5 V Tolerant Inputs — Interface Capability With 5 V TTL Logic
- LVTTTL Compatible
- LVC MOS Compatible
- Near Zero Static Supply Current (10 μ A) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500 mA
- ESD Performance: Human Body Model >2000 V; Machine Model >200 V



ON Semiconductor

<http://onsemi.com>

MARKING DIAGRAMS



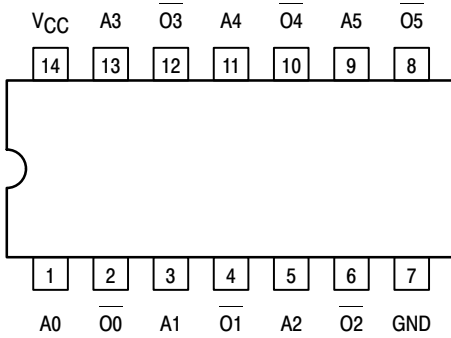
A = Assembly Location
 WL, L = Wafer Lot
 Y = Year
 WW, W = Work Week

ORDERING INFORMATION

Device	Package	Shipping
MC74LCXU04D	SO-14	55 Units/Rail
MC74LCXU04DR2	SO-14	2500 Units/Reel
MC74LCXU04DT	TSSOP-14	96 Units/Rail
MC74LCXU04DTR2	TSSOP-14	2500 Units/Reel
MC74LCXU04M	SOIC EIAJ-14	50 Units/Rail
MC74LCXU04MEL	SOIC EIAJ-14	2000 Units/Reel

MC74LCXU04

PINOUT: 14-LEAD (Top View)



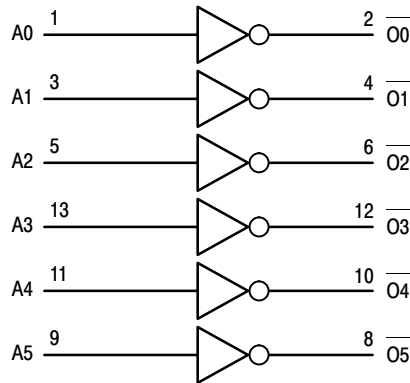
PIN NAMES

Pins	Function
A_n	Data Inputs
O_n	Outputs

TRUTH TABLE

A_n	O_n
L	H
H	L

LOGIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS*

Symbol	Parameter	Value	Condition	Unit
V_{CC}	DC Supply Voltage	-0.5 to +7.0		V
V_I	DC Input Voltage	$-0.5 \leq V_I \leq +7.0$		V
V_O	DC Output Voltage	$-0.5 \leq V_O \leq V_{CC} + 0.5$	Output in HIGH or LOW State. (Note 1.)	V
I_{IK}	DC Input Diode Current	-50	$V_I < GND$	mA
I_{OK}	DC Output Diode Current	-50	$V_O < GND$	mA
		+50	$V_O > V_{CC}$	mA
I_O	DC Output Source/Sink Current	± 50		mA
I_{CC}	DC Supply Current Per Supply Pin	± 100		mA
I_{GND}	DC Ground Current Per Ground Pin	± 100		mA
T_{STG}	Storage Temperature Range	-65 to +150		$^{\circ}C$

* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.

1. I_O absolute maximum rating must be observed.

MC74LCXU04

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Typ	Max	Unit	
V _{CC}	Supply Voltage	Operating	2.0	2.5, 3.3	3.6	V
		Data Retention Only	1.5	2.5, 3.3	3.6	
V _I	Input Voltage	0		5.5	V	
V _O	Output Voltage (HIGH or LOW State)	0		V _{CC}	V	
I _{OH}	HIGH Level Output Current			-18 -12 -8	mA	
I _{OL}	LOW Level Output Current	V _{CC} = 3.0V – 3.6V			+16	mA
		V _{CC} = 2.7V – 3.0V			+12	
		V _{CC} = 2.3V – 2.7V			+8	
T _A	Operating Free-Air Temperature	-40		+85	°C	
Δt/ΔV	Input Transition Rise or Fall Rate, V _{IIN} from 0.8V to 2.0V, V _{CC} = 3.0V	0		10	ns/V	

DC ELECTRICAL CHARACTERISTICS

Symbol	Characteristic	Condition	T _A = -40°C to +85°C		Unit
			Min	Max	
V _{IH}	HIGH Level Input Voltage (Note 2.)	V _{CC} = 2.3 V	1.7		V
		V _{CC} = 2.7 V	2.1		
		V _{CC} = 3.0 V	2.2		
		V _{CC} = 3.6 V	2.7		
V _{IL}	LOW Level Input Voltage (Note 2.)	V _{CC} = 2.3 V		0.55	V
		V _{CC} = 2.7 V		0.55	
		V _{CC} = 3.0 V		0.55	
		V _{CC} = 3.6 V		0.55	
V _{OH}	HIGH Level Output Voltage	2.3 V ≤ V _{CC} ≤ 3.6 V; I _{OL} = 100 μA	V _{CC} - 0.2		V
		V _{CC} = 2.3 V; I _{OH} = -8 mA	1.8		
		V _{CC} = 2.7 V; I _{OH} = -12 mA	2.2		
		V _{CC} = 3.0 V; I _{OH} = -18 mA	2.4		
V _{OL}	LOW Level Output Voltage	2.3 V ≤ V _{CC} ≤ 3.6 V; I _{OL} = 100 μA		0.2	V
		V _{CC} = 2.3 V; I _{OL} = 8 mA		0.6	
		V _{CC} = 2.7 V; I _{OL} = 12 mA		0.4	
		V _{CC} = 3.0 V; I _{OL} = 16 mA		0.5	
I _I	Input Leakage Current	2.3 V ≤ V _{CC} ≤ 3.6 V; 0 V ≤ V _I ≤ 5.5 V		±5.0	μA
I _{OZ}	3-State Output Current	2.3 ≤ V _{CC} ≤ 3.6 V; 0V ≤ V _O ≤ 5.5 V; V _I = V _{IH} or V _{IL}		±5.0	μA
I _{OFF}	Power-Off Leakage Current	V _{CC} = 0 V; V _I or V _O = 5.5 V		10	μA
I _{CC}	Quiescent Supply Current	2.3 ≤ V _{CC} ≤ 3.6 V; V _I = GND or V _{CC}		10	μA
		2.3 ≤ V _{CC} ≤ 3.6 V; 3.6 ≤ V _I or V _O ≤ 5.5 V		±10	
ΔI _{CC}	Increase in I _{CC} per Input	2.3 ≤ V _{CC} ≤ 3.6 V; V _{IH} = V _{CC} - 0.6 V		500	μA

2. These values of V_I are used to test DC electrical characteristics only.

MC74LCXU04

AC CHARACTERISTICS $t_R = t_F = 2.5\text{ns}$; $R_L = 500\ \Omega$ (Note 3.)

Symbol	Parameter	Waveform	Limits						Unit
			$T_A = -40^\circ\text{C to } +85^\circ\text{C}$						
			$V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 2.5\text{ V} \pm 0.2\text{ V}$		
			$C_L = 50\text{ pF}$		$C_L = 50\text{ pF}$		$C_L = 30\text{ pF}$		
			Min	Max	Min	Max	Min	Max	
t_{PLH} t_{PHL}	Propagation Delay Input to Output	1	1.0 1.0	3.6 3.6	1.0 1.0	4.5 4.5	1.0 1.0	4.3 4.3	ns
t_{OSHL} t_{OSLH}	Output-to-Output Skew (Note 4.)			1.0 1.0					ns

- These AC parameters are preliminary and may be modified.
- Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}); parameter guaranteed by design.

DYNAMIC SWITCHING CHARACTERISTICS

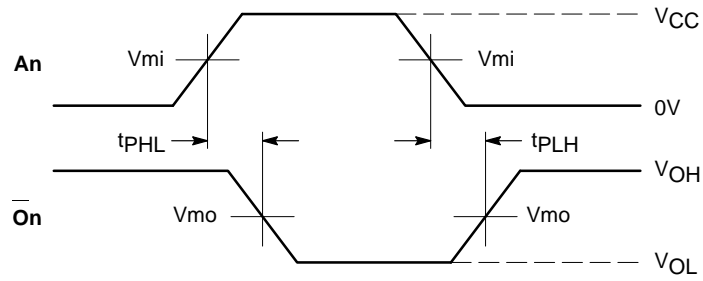
Symbol	Characteristic	Condition	$T_A = +25^\circ\text{C}$			Unit
			Min	Typ	Max	
V_{OLP}	Dynamic LOW Peak Voltage (Note 5.)	$V_{CC} = 3.3\text{ V}, C_L = 50\text{ pF}, V_{IH} = 3.3\text{ V}, V_{IL} = 0\text{ V}$ $V_{CC} = 2.5\text{ V}, C_L = 30\text{ pF}, V_{IH} = 2.5\text{ V}, V_{IL} = 0\text{ V}$		0.8 0.6		V V
V_{OLV}	Dynamic LOW Valley Voltage (Note 5.)	$V_{CC} = 3.3\text{ V}, C_L = 50\text{ pF}, V_{IH} = 3.3\text{ V}, V_{IL} = 0\text{ V}$ $V_{CC} = 2.5\text{ V}, C_L = 30\text{ pF}, V_{IH} = 2.5\text{ V}, V_{IL} = 0\text{ V}$		-0.8 -0.6		V V

- Number of outputs defined as "n". Measured with "n-1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

CAPACITIVE CHARACTERISTICS

Symbol	Parameter	Condition	Typical	Unit
C_{IN}	Input Capacitance	$V_{CC} = 3.3\text{V}, V_I = 0\text{V or } V_{CC}$	7	pF
C_{OUT}	Output Capacitance	$V_{CC} = 3.3\text{V}, V_I = 0\text{V or } V_{CC}$	8	pF
C_{PD}	Power Dissipation Capacitance	10 MHz, $V_{CC} = 3.3\text{V}, V_I = 0\text{V or } V_{CC}$	25	pF

MC74LCXU04

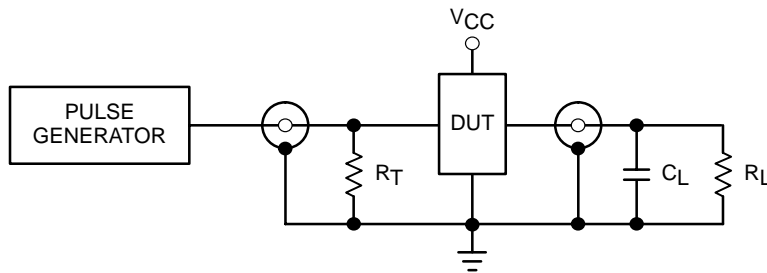


PROPAGATION DELAYS

$t_R = t_F = 2.5 \text{ ns}$, 10% to 90%; $f = 1 \text{ MHz}$; $t_{WJ} = 500 \text{ ns}$

Symbol	V _{CC}		
	3.3 V ± 0.3 V	2.7 V	2.5 V ± 0.2 V
V _{mi}	1.5 V	1.5 V	V _{CC} /2
V _{mo}	1.5 V	1.5 V	V _{CC} /2

Figure 1. AC Waveforms



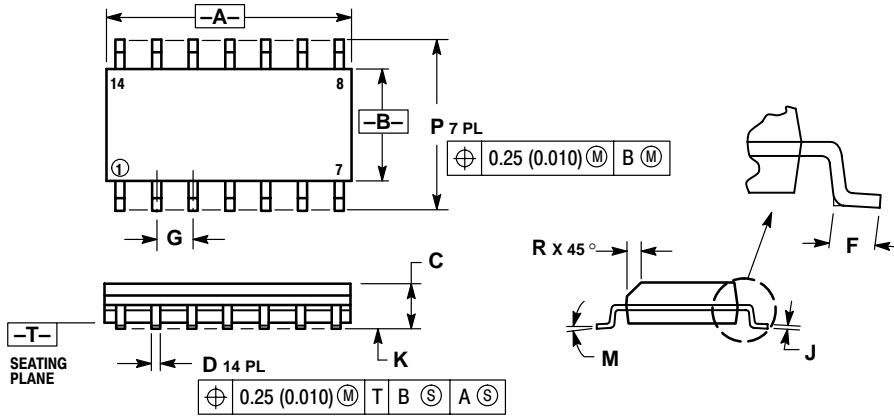
- C_L = 50 pF at V_{CC} = 3.3 ± 0.3 V or equivalent (includes jig and probe capacitance)
- C_L = 30 pF at V_{CC} = 2.5 ± 0.2 V or equivalent (includes jig and probe capacitance)
- R_L = R₁ = 500 Ω or equivalent
- R_T = Z_{OUT} of pulse generator (typically 50 Ω)

Figure 2. Test Circuit

MC74LCXU04

PACKAGE DIMENSIONS

SO-14
D SUFFIX
CASE 751A-03
ISSUE F



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.228	0.244
R	0.25	0.50	0.010	0.019

STYLE 1:

- PIN 1. COMMON CATHODE
- 2. ANODE/CATHODE
- 3. ANODE/CATHODE
- 4. NO CONNECTION
- 5. ANODE/CATHODE
- 6. NO CONNECTION
- 7. ANODE/CATHODE
- 8. ANODE/CATHODE
- 9. ANODE/CATHODE
- 10. NO CONNECTION
- 11. ANODE/CATHODE
- 12. ANODE/CATHODE
- 13. NO CONNECTION
- 14. COMMON ANODE

STYLE 2:

CANCELLED

STYLE 3:

- PIN 1. NO CONNECTION
- 2. ANODE
- 3. ANODE
- 4. NO CONNECTION
- 5. ANODE
- 6. NO CONNECTION
- 7. ANODE
- 8. ANODE
- 9. ANODE
- 10. NO CONNECTION
- 11. ANODE
- 12. ANODE
- 13. NO CONNECTION
- 14. COMMON CATHODE

STYLE 4:

- PIN 1. NO CONNECTION
- 2. CATHODE
- 3. CATHODE
- 4. NO CONNECTION
- 5. CATHODE
- 6. NO CONNECTION
- 7. CATHODE
- 8. CATHODE
- 9. CATHODE
- 10. NO CONNECTION
- 11. CATHODE
- 12. CATHODE
- 13. NO CONNECTION
- 14. COMMON ANODE

STYLE 5:

- PIN 1. COMMON CATHODE
- 2. ANODE/CATHODE
- 3. ANODE/CATHODE
- 4. ANODE/CATHODE
- 5. ANODE/CATHODE
- 6. NO CONNECTION
- 7. COMMON ANODE
- 8. COMMON CATHODE
- 9. ANODE/CATHODE
- 10. ANODE/CATHODE
- 11. ANODE/CATHODE
- 12. ANODE/CATHODE
- 13. NO CONNECTION
- 14. COMMON ANODE

STYLE 6:

- PIN 1. CATHODE
- 2. CATHODE
- 3. CATHODE
- 4. CATHODE
- 5. CATHODE
- 6. CATHODE
- 7. CATHODE
- 8. ANODE
- 9. ANODE
- 10. ANODE
- 11. ANODE
- 12. ANODE
- 13. ANODE
- 14. ANODE

STYLE 7:

- PIN 1. ANODE/CATHODE
- 2. COMMON ANODE
- 3. COMMON CATHODE
- 4. ANODE/CATHODE
- 5. ANODE/CATHODE
- 6. ANODE/CATHODE
- 7. ANODE/CATHODE
- 8. ANODE/CATHODE
- 9. ANODE/CATHODE
- 10. ANODE/CATHODE
- 11. COMMON CATHODE
- 12. COMMON ANODE
- 13. ANODE/CATHODE
- 14. ANODE/CATHODE

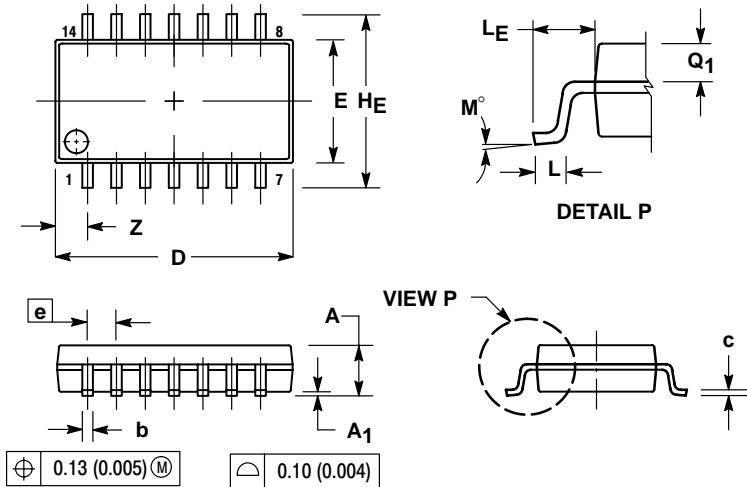
STYLE 8:

- PIN 1. COMMON CATHODE
- 2. ANODE/CATHODE
- 3. ANODE/CATHODE
- 4. NO CONNECTION
- 5. ANODE/CATHODE
- 6. ANODE/CATHODE
- 7. COMMON ANODE
- 8. COMMON ANODE
- 9. ANODE/CATHODE
- 10. ANODE/CATHODE
- 11. NO CONNECTION
- 12. ANODE/CATHODE
- 13. ANODE/CATHODE
- 14. COMMON CATHODE

MC74LCXU04

PACKAGE DIMENSIONS

SOIC EIAJ-14
M SUFFIX
CASE 965-01
ISSUE O

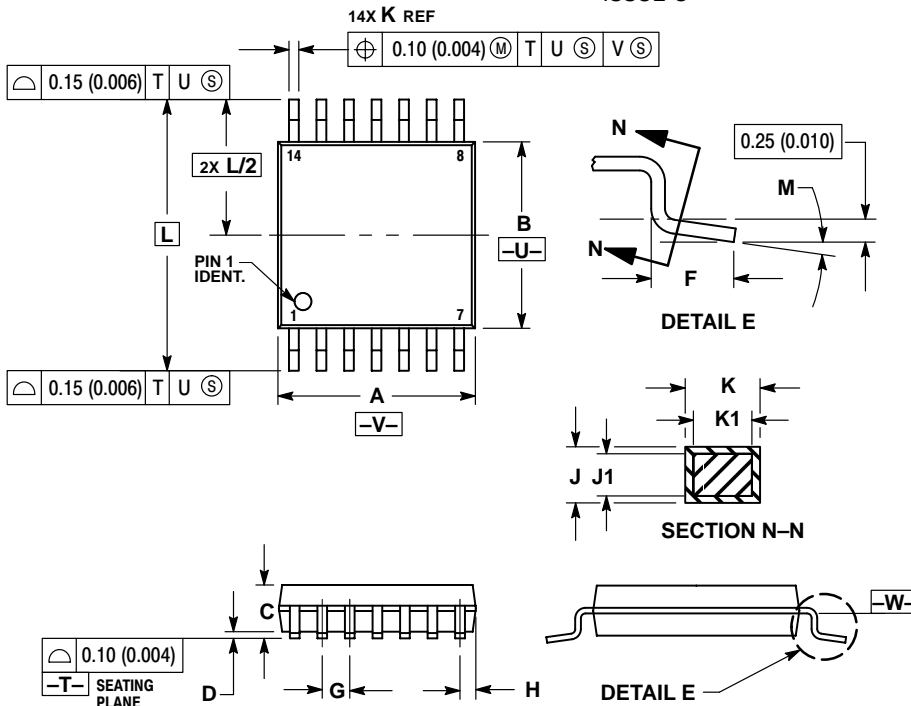


NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS AND ARE MEASURED AT THE PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
5. THE LEAD WIDTH DIMENSION (b) DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE LEAD WIDTH DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CANNOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT. MINIMUM SPACE BETWEEN PROTRUSIONS AND ADJACENT LEAD TO BE 0.46 (0.018).

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	---	2.05	---	0.081
A ₁	0.05	0.20	0.002	0.008
b	0.35	0.50	0.014	0.020
c	0.18	0.27	0.007	0.011
D	9.90	10.50	0.390	0.413
E	5.10	5.45	0.201	0.215
e	1.27 BSC		0.050 BSC	
H _E	7.40	8.20	0.291	0.323
L	0.50	0.85	0.020	0.033
L _E	1.10	1.50	0.043	0.059
M	0°	10°	0°	10°
Q ₁	0.70	0.90	0.028	0.035
Z	---	1.42	---	0.056


TSSOP-14
DT SUFFIX
CASE 948G-01
ISSUE O



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W-.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.90	5.10	0.193	0.200
B	4.30	4.50	0.169	0.177
C	---	1.20	---	0.047
D	0.05	0.15	0.002	0.006
F	0.50	0.75	0.020	0.030
G	0.65 BSC		0.026 BSC	
H	0.50	0.60	0.020	0.024
J	0.09	0.20	0.004	0.008
J ₁	0.09	0.16	0.004	0.006
K	0.19	0.30	0.007	0.012
K ₁	0.19	0.25	0.007	0.010
L	6.40 BSC		0.252 BSC	
M	0°	8°	0°	8°

ON Semiconductor and  are trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer.

PUBLICATION ORDERING INFORMATION

NORTH AMERICA Literature Fulfillment:

Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada
Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada
Email: ONlit@hibbertco.com
Fax Response Line: 303-675-2167 or 800-344-3810 Toll Free USA/Canada

N. American Technical Support: 800-282-9855 Toll Free USA/Canada

EUROPE: LDC for ON Semiconductor – European Support

German Phone: (+1) 303-308-7140 (Mon-Fri 2:30pm to 7:00pm CET)
Email: ONlit-german@hibbertco.com
French Phone: (+1) 303-308-7141 (Mon-Fri 2:00pm to 7:00pm CET)
Email: ONlit-french@hibbertco.com
English Phone: (+1) 303-308-7142 (Mon-Fri 12:00pm to 5:00pm GMT)
Email: ONlit@hibbertco.com

EUROPEAN TOLL-FREE ACCESS*: 00-800-4422-3781

*Available from Germany, France, Italy, UK, Ireland

CENTRAL/SOUTH AMERICA:

Spanish Phone: 303-308-7143 (Mon-Fri 8:00am to 5:00pm MST)
Email: ONlit-spanish@hibbertco.com

ASIA/PACIFIC: LDC for ON Semiconductor – Asia Support

Phone: 303-675-2121 (Tue-Fri 9:00am to 1:00pm, Hong Kong Time)
Toll Free from Hong Kong & Singapore:
001-800-4422-3781
Email: ONlit-asia@hibbertco.com

JAPAN: ON Semiconductor, Japan Customer Focus Center
4-32-1 Nishi-Gotanda, Shinagawa-ku, Tokyo, Japan 141-0031
Phone: 81-3-5740-2700

Email: r14525@onsemi.com

ON Semiconductor Website: <http://onsemi.com>

For additional information, please contact your local Sales Representative.